

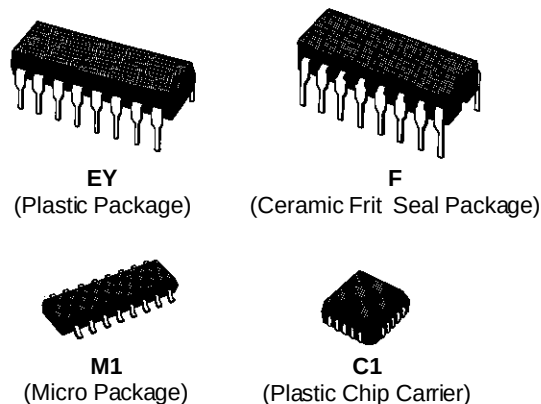
DECADE COUNTERS/DIVIDERS WITH DECODED 7-SEGMENT DISPLAY OUTPUTS

WITH; DISPLAY ENABLE 4026B RIPPLE BLANKING 4033B

- COUNTER AND 7-SEGMENT DECODING IN ONE PACKAGE
- EASILY INTERFACED WITH 7-SEGMENT DISPLAY TYPES
- FULLY STATIC COUNTER OPERATION : DC TO 6MHz (typ.) AT $V_{DD} = 10V$
- IDEAL FOR LOW-POWER DISPLAYS
- DISPLAY ENABLE OUTPUT - 4026B
- "RIPPLE BLANKING" AND LAMP TEST - 4033B
- QUIESCENT CURRENT SPECIFIED TO 20V FOR HCC DEVICE
- STANDARDIZED SYMMETRICAL OUTPUT CHARACTERISTICS
- 5V, 10V, AND 15V PARAMETRIC RATING
- INPUT CURRENT OF 100nA AT 18V AND 25°C FOR HCC DEVICE
- 100% TESTED FOR QUIESCENT CURRENT
- MEETS ALL REQUIREMENTS OF JEDEC TENTATIVE STANDARD N° 13A, "STANDARD SPECIFICATIONS FOR DESCRIPTION OF "B" SERIES CMOS DEVICES"

DESCRIPTION

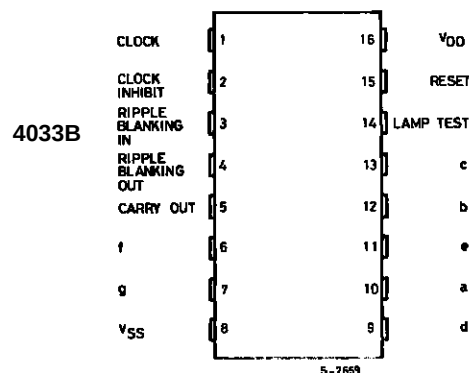
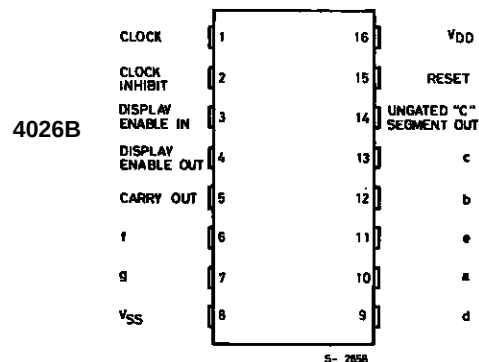
The **HCC4026B/4033B** (extended temperature range) and **HCF4026B/4033B** (intermediate temperature range) are monolithic integrated circuits, available in 16-lead dual in-line plastic or ceramic package and plastic micro package. The **HCC/HCF4026B** and **HCC/HCF4033B** each consist of a 5-stage Johnson decade counter and an output decoder which converts the Johnson code to a 7-segment decoded output for driving one stage in a numerical display. These devices are particularly advantageous in display applications where low power dissipation and/or low package count are important. Inputs common to both types are CLOCK, RESET, & CLOCK INHIBIT ; common outputs are CARRY OUT and the seven decoded outputs (a, b, c, d, e, f, g). Additional inputs and outputs for the **HCC/HCF4026B** include DISPLAY ENABLE input and DISPLAY ENABLE and UNGATED "C" SEGMENT outputs. Signals peculiar to the **HCC/HCF4033B** are RIPPLE-BLANKING INPUT AND LAMP TEST INPUT and a RIPPLE-BLANKING OUTPUT. A high RESET signal clears the de-



ORDER CODES :

HCC40XXBF	HCF40XXBM1
HCF40XXBEY	HCF40XXBC1

PIN CONNECTIONS



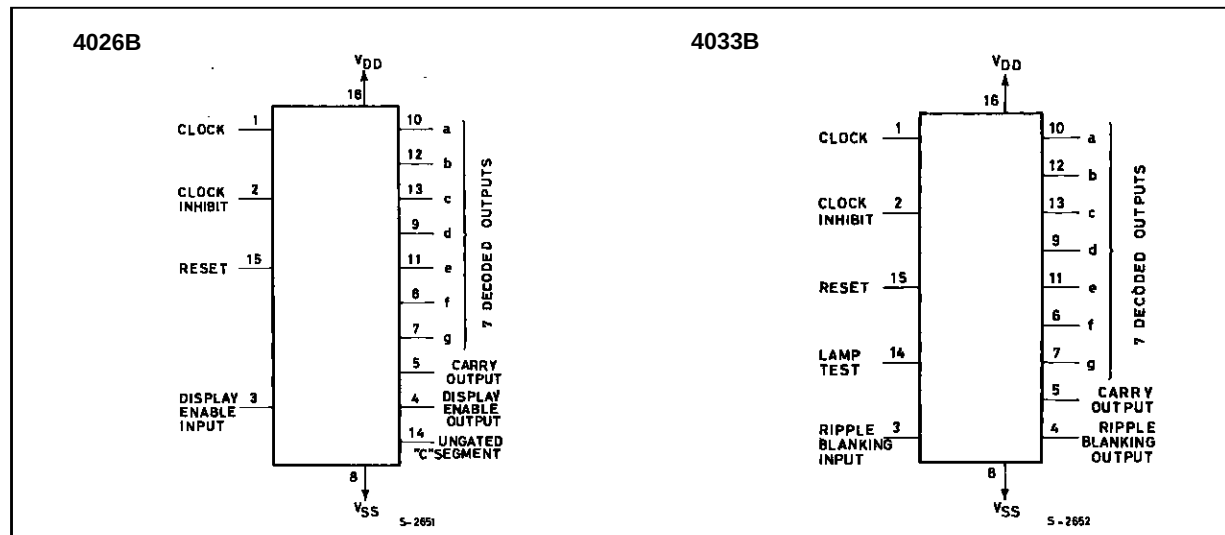
cade counter to its zero count. The counter is advanced one count at the positive clock signal transition if the CLOCK INHIBIT signal is low. Counter advancement via the clock line is inhibited when the CLOCK INHIBIT signal is high. Antilock gating is provided on the JOHNSON counter, thus assuring proper counting sequence. The CARRY-OUT (C_{out}) signal completes one cycle every ten CLOCK INPUT cycles and is used to clock the succeeding decade directly in a multi-decade counting chain. The seven decoded outputs (a, b, c, d, e, f, g) illuminate the proper segments in a seven segment display device used for representing the decimal numbers 0 to 9. The 7-segment outputs go high on selection in the **HCC/HCF4033B** ; in the **HCC/HCF4026B** these outputs go high only when the DISPLAY ENABLE IN is high.

HCC/HCF4026B - When the DISPLAY ENABLE IN is low the seven decoded outputs are forced low regardless of the state of the counter. Activation of the display only when required results in significant power savings. This system also facilitates implementation of display-character multiplexing. The CARRY OUT and UNGATED "C-SEGMENT" signals are not gated by the DISPLAY ENABLE and therefore are available continuously. This feature is a requirement in implementation of certain divider functions such as divide-by-60 and divide-by-12.

HCC/HCF4033B - The **HCC/HCF4033B** has provisions for automatic blanking of the non-significant zeros in a multi-digit decimal number which results in an easily readable display consistent with

normal writing practice. For example, the number 0050.07000 in an eight digit display would be displayed as 50.07. Zero suppression on the integer side is obtained by connecting the RBI terminal of the **HCC/HCF4033B** associated with the most significant digit in the display to a low-level voltage and connecting the RBO terminal of that stage to the RBI terminal of the **HCC/HCF4033B** in the next-lower significant position in the display. This procedure is continued for each succeeding **HCC/HCF4033B** on the integer side of the display. On the fraction side of the display the RBI of the **HCC/HCF4033B** associated with the least significant bit is connected to a low-level voltage and the RBO of that **HCC/HCF4033B** is connected to the RBI terminal of the **HCC/HCF4033B** in the next more-significant-bit position. Again, this procedure is continued for all **HCC/HCF4033B**'s on the fraction side of the display. In a purely fractional number the zero immediately preceding the decimal point can be displayed by connecting the RBI of that stage to a high level voltage (instead of to the RBO of the next more-significant-stage). For example : optional zero $\rightarrow$ 0.7346. Likewise, the zero in a number such as 763.0 can be displayed by connecting the RBI of the **HCC/HCF4033B** associated with it to a high-level voltage. Ripple blanking of non-significant zeros provides an appreciable savings in display power. The **HCC/HCF4033B** has a LAMP TEST input which, when connected to a high-level voltage, overrides normal decoder operation and enables a check to be made on possible display malfunctions by putting the seven outputs in the high state.

FUNCTIONAL DIAGRAMS



ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V_{DD}^*	Supply Voltage : HCC Types	– 0.5 to + 20	V
	HCF Types	– 0.5 to + 18	V
V_i	Input Voltage	– 0.5 to $V_{DD} + 0.5$	V
I_i	DC Input Current (any one input)	± 10	mA
P_{tot}	Total Power Dissipation (per package)	200	mW
	Dissipation per Output Transistor for T_{op} = Full Package-temperature Range	100	mW
T_{op}	Operating Temperature : HCC Types	– 55 to + 125	°C
	HCF Types	– 40 to + 85	°C
T_{stg}	Storage Temperature	– 65 to + 150	°C

Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for external periods may affect device reliability.

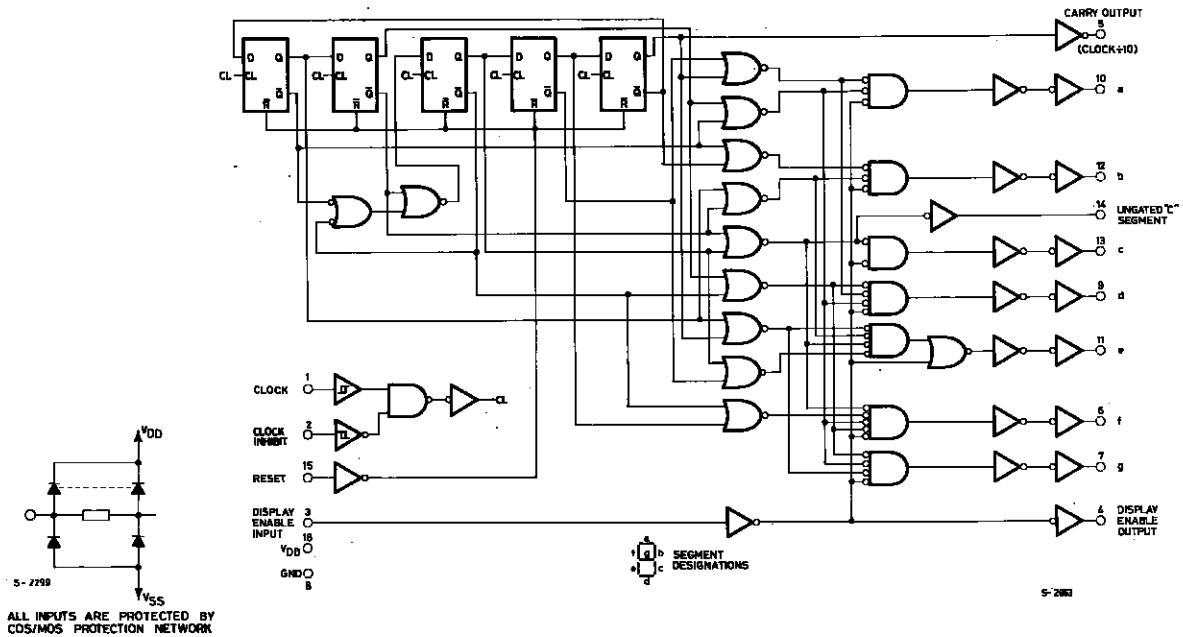
* All voltages values are referred to V_{SS} pin voltage.

RECOMMENDED OPERATING CONDITIONS

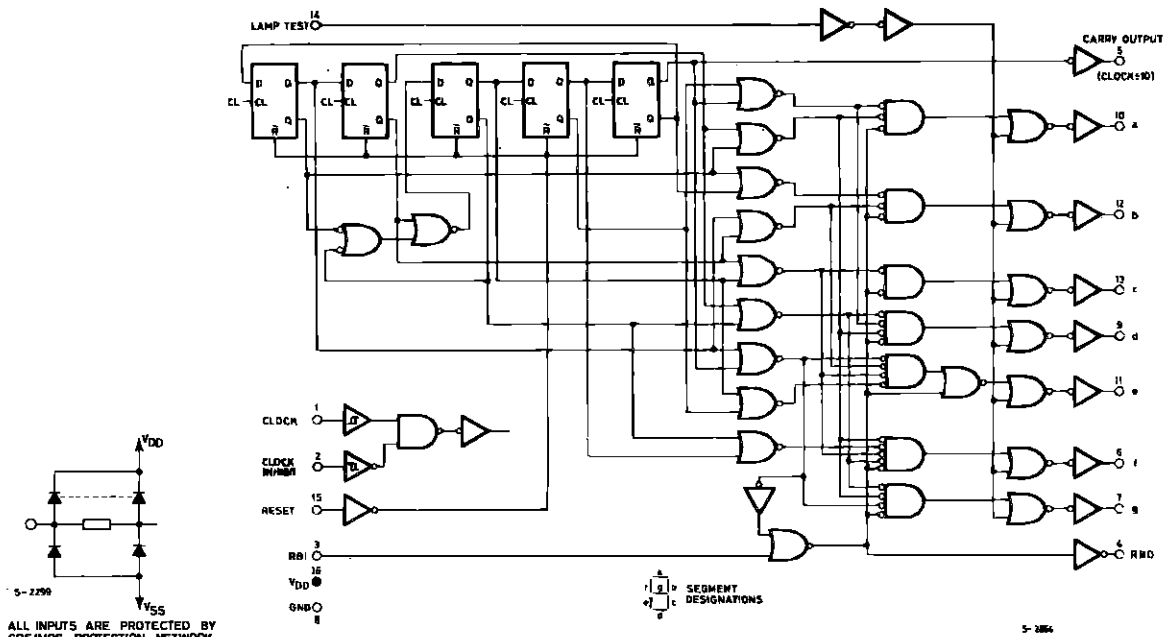
Symbol	Parameter	Value	Unit
V_{DD}	Supply Voltage : HCC Types	3 to 18	V
	HCF Types	3 to 15	V
V_i	Input Voltage	0 to V_{DD}	V
T_{op}	Operating Temperature : HCC Types	– 55 to + 125	°C
	HCF Types	– 40 to + 85	°C

LOGIC DIAGRAMS

4026B

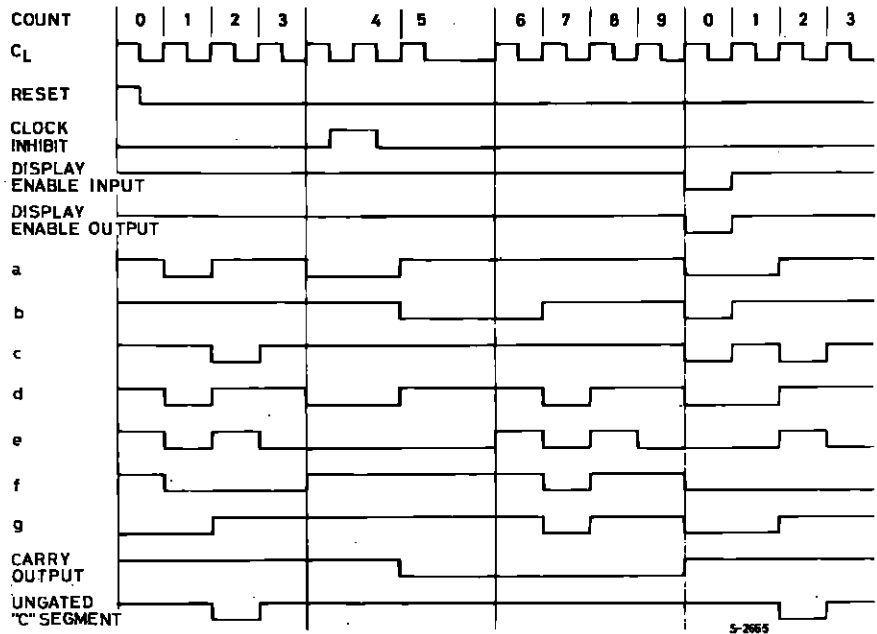


4033B

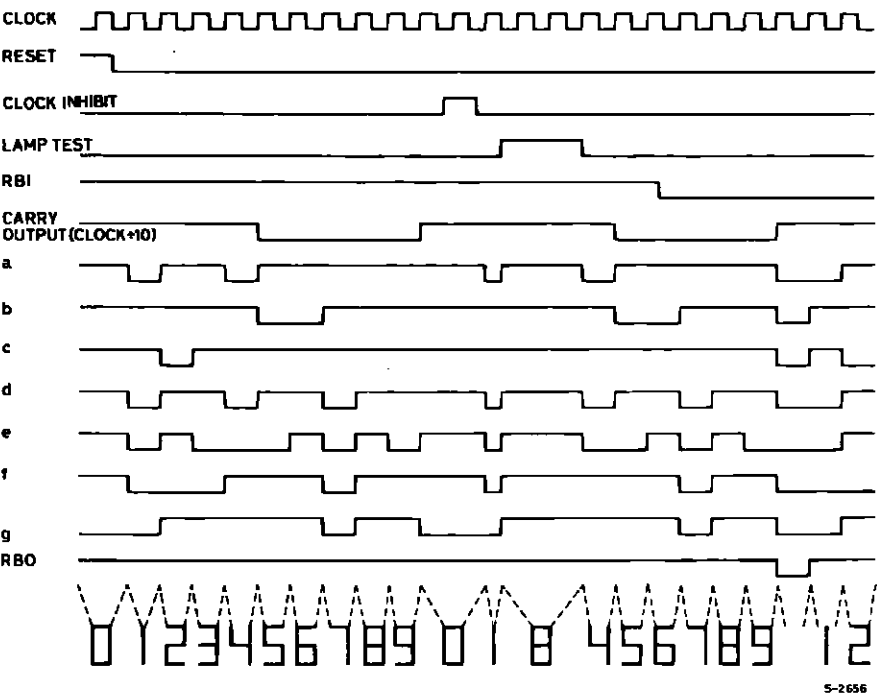


TIMING DIAGRAMS

4026B



4033B



STATIC ELECTRICAL CHARACTERISTICS (over recommended operating conditions)

Symbol	Parameter		Test Conditions				Value							Unit
			V _I (V)	V _O (V)	I _O (μA)	V _{DD} (V)	T _{Low} [*]		25° C			T _{High} [*]		
							Min.	Max.	Min.	Typ.	Max.	Min.	Max.	
I _L	Quiescent Current	HCC Types	0/ 5			5		5		0.04	5		150	μA
			0/10			10		10		0.04	10		300	
			0/15			15		20		0.04	20		600	
			0/20			20		100		0.08	100		3000	
		HCF Types	0/ 5			5		20		0.04	20		150	
			0/10			10		40		0.04	40		300	
			0/15			15		80		0.04	80		600	
V _{OH}	Output High Voltage	0/ 5		< 1	5	4.95		4.95			4.95		V	
		0/10		< 1	10	9.95		9.95			9.95			
		0/15		< 1	15	14.95		14.95			14.95			
V _{OL}	Output Low Voltage	5/0		< 1	5		0.05			0.05		0.05	V	
		10/0		< 1	10		0.05			0.05		0.05		
		15/0		< 1	15		0.05			0.05		0.05		
V _{IH}	Input High Voltage		0.5/4.5	< 1	5	3.5		3.5			3.5		V	
			1/9	< 1	10	7		7			7			
			1.5/13.5	< 1	15	11		11			11			
V _{IL}	Input Low Voltage		4.5/0.5	< 1	5		1.5			1.5		1.5	V	
			9/1	< 1	10		3			3		3		
			13.5/1.5	< 1	15		4			4		4		
I _{OH}	Output Drive Current	HCC Types	0/ 5	2.5		5	– 2		– 1.6	– 3.2		– 1.15		mA
			0/ 5	4.6		5	– 0.64		– 0.51	– 1		– 0.36		
			0/10	9.5		10	– 1.6		– 1.3	– 2.6		– 0.9		
			0/15	13.5		15	– 4.2		– 3.4	– 6.8		– 2.4		
		HCF Types	0/ 5	2.5		5	– 1.53		– 1.36	– 3.2		– 1.1		
			0/ 5	4.6		5	– 0.52		– 0.44	– 1		– 0.36		
			0/10	9.5		10	– 1.3		– 1.1	– 2.6		– 0.9		
			0/15	13.5		15	– 3.6		– 3.0	– 6.8		– 2.4		
I _{OL}	Output Sink Current	HCC Types	0/ 5	0.4		5	0.64		0.51	1		0.36		mA
			0/10	0.5		10	1.6		1.3	2.6		0.9		
			0/15	1.5		15	4.2		3.4	6.8		2.4		
		HCF Types	0/ 5	0.4		5	0.52		0.44	1		0.36		
			0/10	0.5		10	1.3		1.1	2.6		0.9		
			0/15	1.5		15	3.6		3.0	6.8		2.4		
I _{IH} , I _{IL}	Input Leakage Current	HCC Types	0/18	Any Input	18		± 0.1		±10 ^{–5}	± 0.1		± 1	μA	
		HCF Types	0/15		15		± 0.3		±10 ^{–5}	± 0.3		± 1		
C _I	Input Capacitance			Any Input					5	7.5			pF	

 (*) T_{Low} = - 55°C for **HCC** device : - 40°C for **HCF** device.

 T_{High} = + 125°C for **HCC** device : + 85°C for **HCF** device.

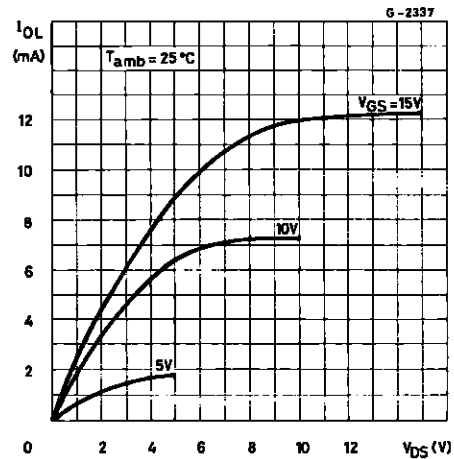
 The Noise Margin for both "1" and "0" level is : 1V min. with V_{DD} = 5V, 2V min. with V_{DD} = 10V, 2.5V min. with V_{DD} = 15V.

DYNAMIC ELECTRICAL CHARACTERISTICS ($T_{amb} = 25^{\circ}\text{C}$, $C_L = 50\text{pF}$, $R_L = 200\text{k}\Omega$, typical temperature coefficient for all V_{DD} values is $0.3\%/^{\circ}\text{C}$, all input rise and fall times = 20ns)

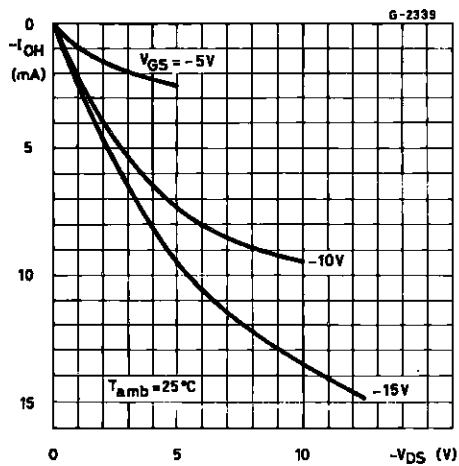
Symbol	Parameter	Test Conditions		Value			Unit
			V _{DD} (V)	Min.	Typ.	Max.	
CLOCKED OPERATION							
t _{PLH} , t _{PHL}	Propagation Delay Time Carry Out Line		5		250	500	ns
			10		100	200	
			15		75	150	
t _{PLH} , t _{PHL}	Propagation Delay Time Decode Out Lines		5		350	700	ns
			10		125	250	
			15		90	180	
t _{THL} , t _{TLH}	Transition Time Carry Out Line		5		100	200	ns
			10		50	100	
			15		25	50	
f _{CL} *	Maximum Clock Input Frequency		5	2.5	5		MHz
			10	5.5	11		
			15	8	16		
t _{WC}	Clock Pulse Width		5		110	270	ns
			10		50	100	
			15		40	80	
t _r , t _f	Clock Input Rise or Fall Time		5 10 15	Unlimited			μs
RESET OPERATION							
t _{PLH} ,	Propagation Delay Time Carry Out Line		5		275	550	ns
			10		120	240	
			15		80	160	
t _{PLH} , t _{PHL}	Propagation Delay Time Decode Out Lines		5		300	600	ns
			10		125	250	
			15		90	180	
t _{WR}	Reset Pulse Width		5		100	120	ns
			10		50	100	
			15		25	50	
t _{rem}	Reset Removal Time		5		0	30	ns
			10		0	15	
			15		0	10	

* Measured with respect to carry output line.

Minimum Output Low (sink) Current Characteristics.

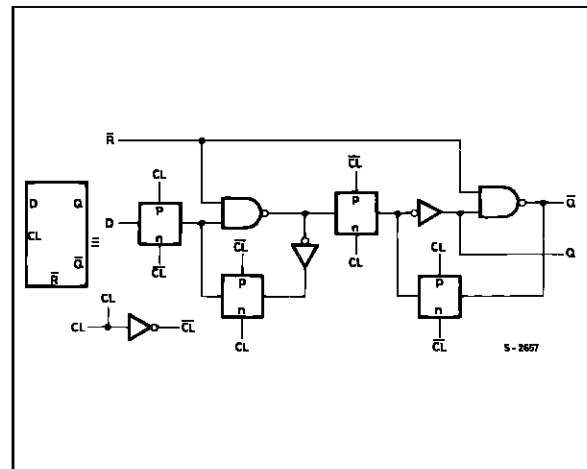


Minimum Output High (source) Current Characteristics.



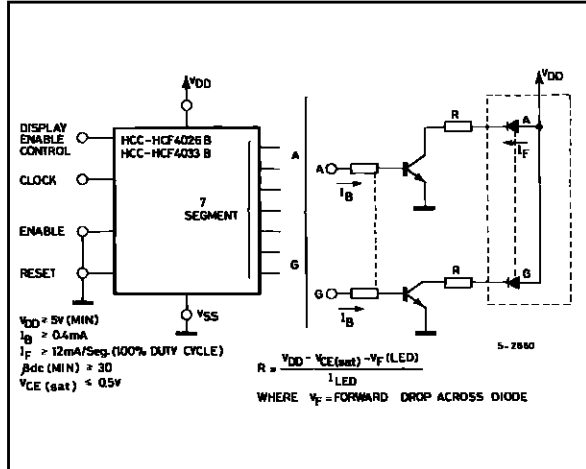
Detail of Typical Flip-flop Stage for Both Types.

Detail of Typical Flip-flop Stage for Both Types.

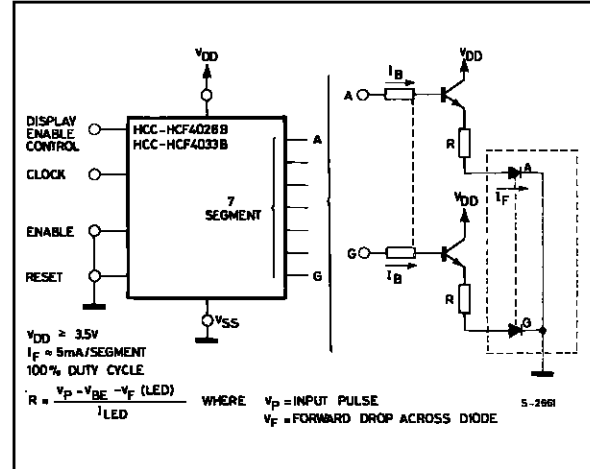


TYPICAL APPLICATIONS (continued)

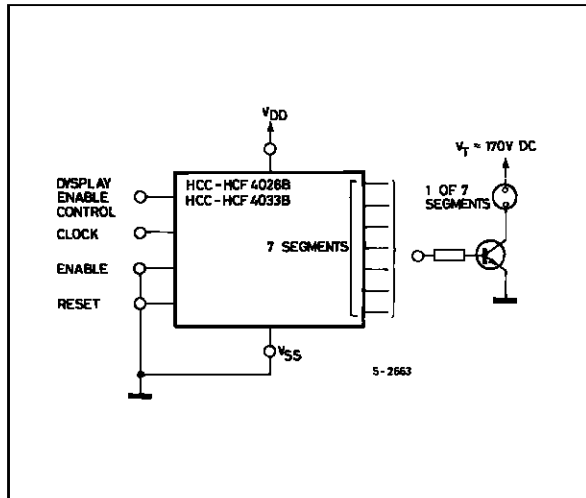
Interfacing with LED Displays (display common anode).



(Display Common Cathode).

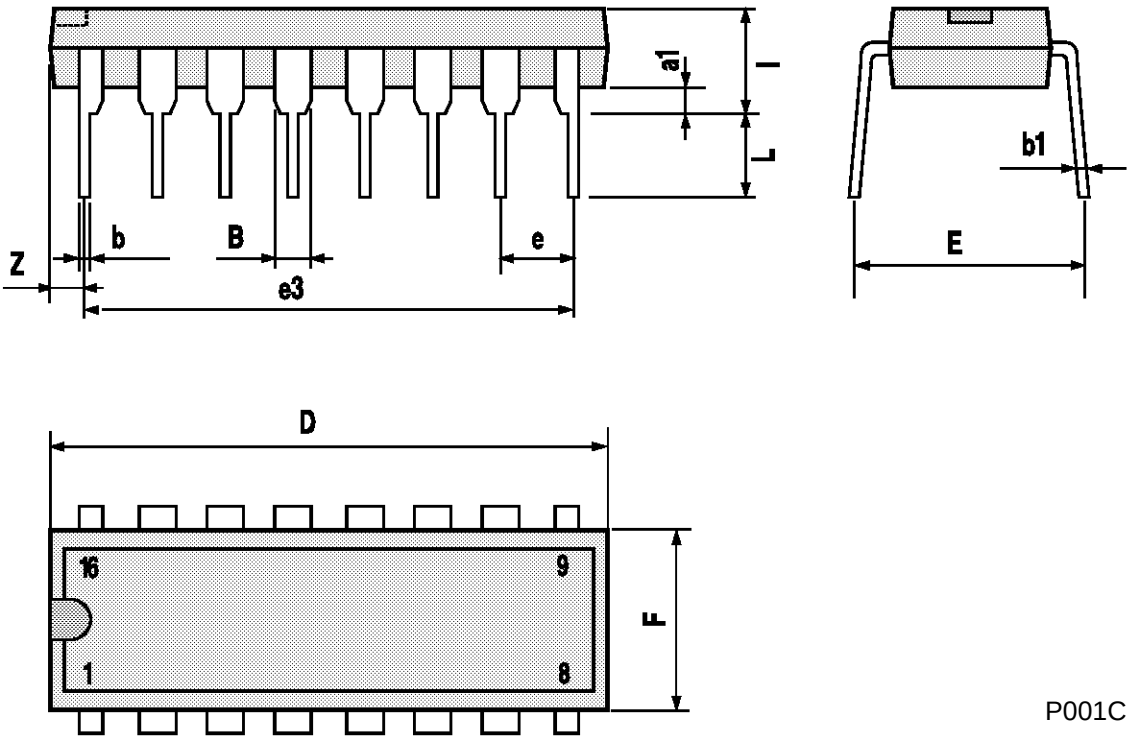


Interfacing with NIXIE Tube.



Plastic DIP16 (0.25) MECHANICAL DATA

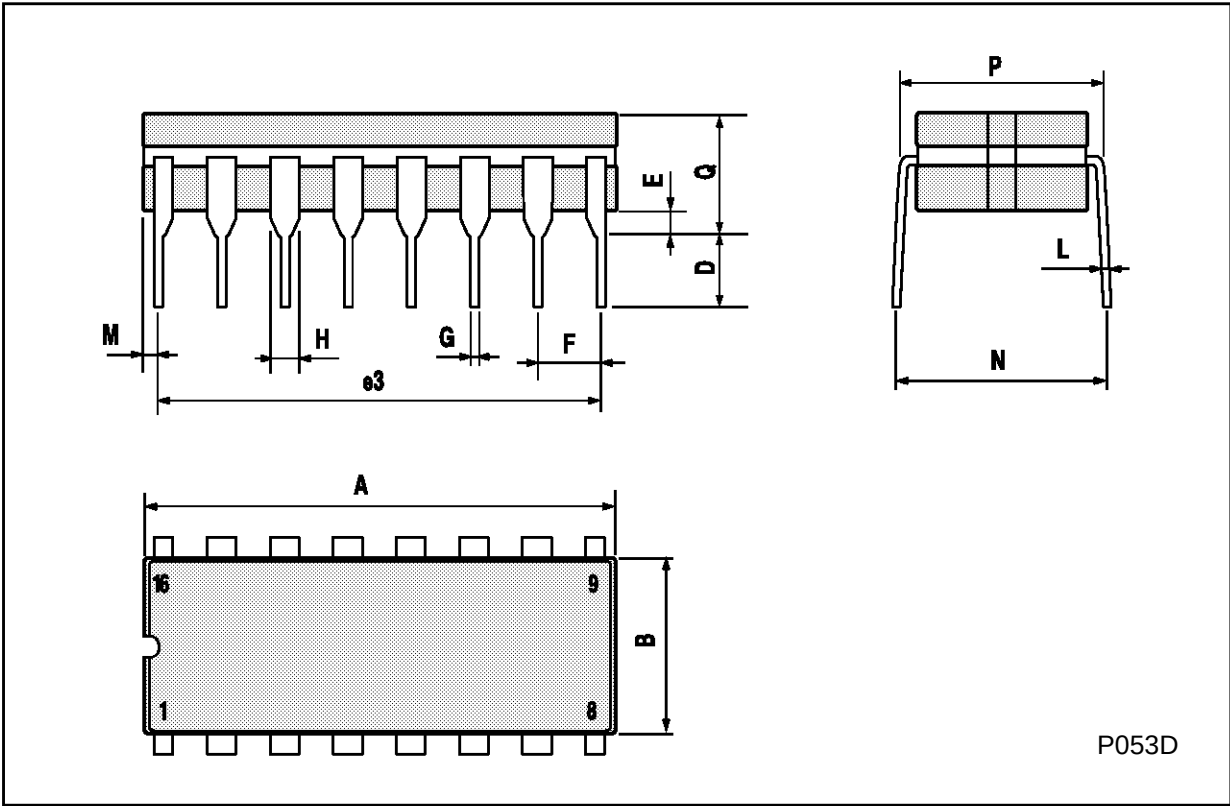
DIM.	mm			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
a1	0.51			0.020		
B	0.77		1.65	0.030		0.065
b		0.5			0.020	
b1		0.25			0.010	
D			20			0.787
E		8.5			0.335	
e		2.54			0.100	
e3		17.78			0.700	
F			7.1			0.280
I			5.1			0.201
L		3.3			0.130	
Z			1.27			0.050



P001C

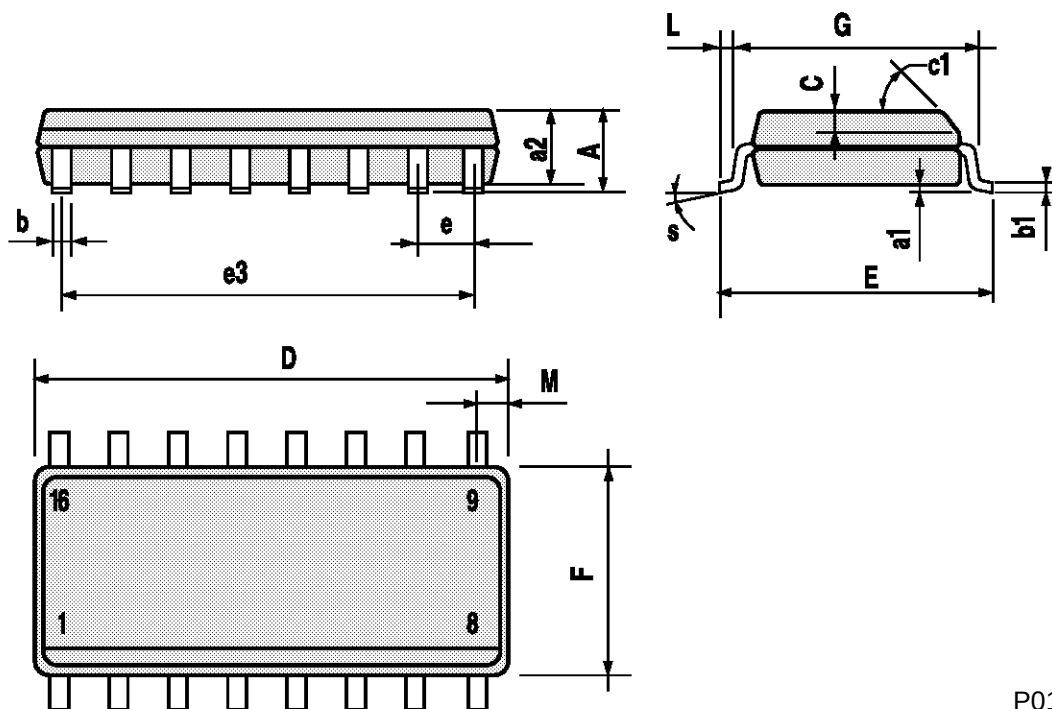
Ceramic DIP16/1 MECHANICAL DATA

DIM.	mm			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A			20			0.787
B			7			0.276
D		3.3			0.130	
E	0.38			0.015		
e3		17.78			0.700	
F	2.29		2.79	0.090		0.110
G	0.4		0.55	0.016		0.022
H	1.17		1.52	0.046		0.060
L	0.22		0.31	0.009		0.012
M	0.51		1.27	0.020		0.050
N			10.3			0.406
P	7.8		8.05	0.307		0.317
Q			5.08			0.200



SO16 (Narrow) MECHANICAL DATA

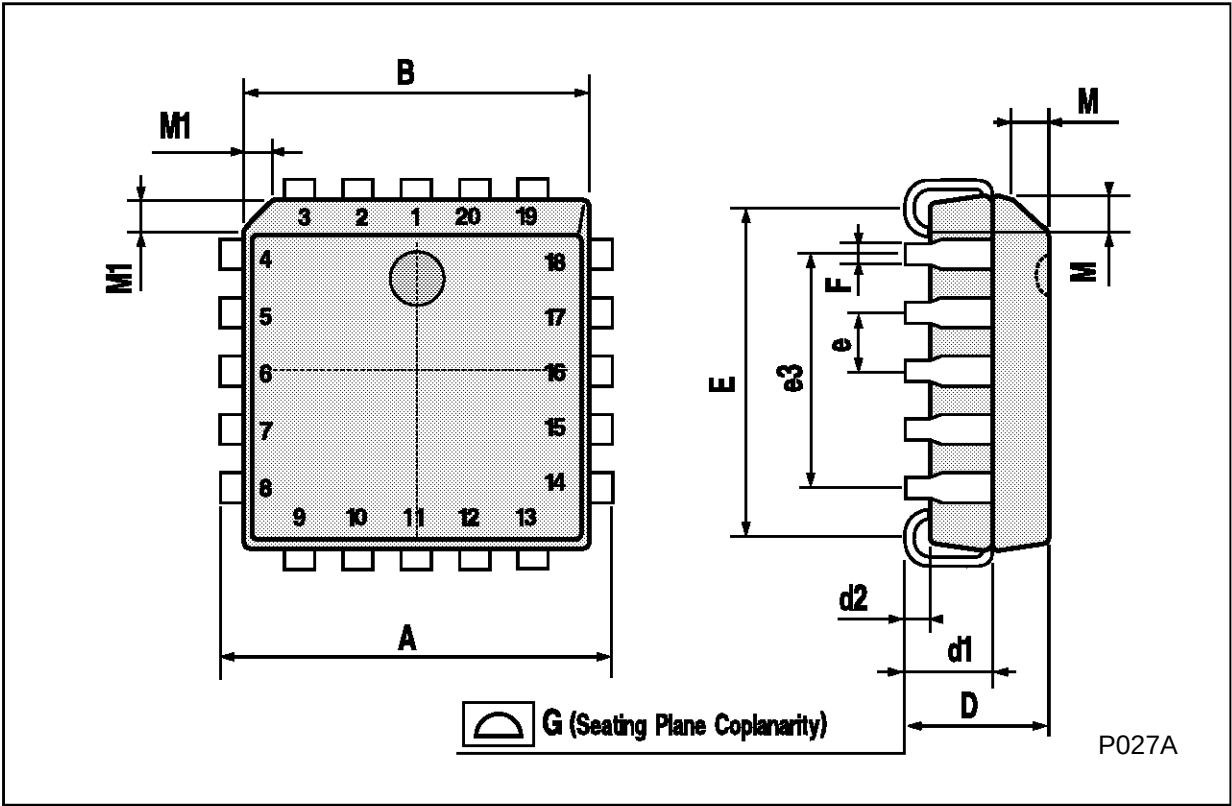
DIM.	mm			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A			1.75			0.068
a1	0.1		0.2	0.004		0.007
a2			1.65			0.064
b	0.35		0.46	0.013		0.018
b1	0.19		0.25	0.007		0.010
C		0.5			0.019	
c1	45° (typ.)					
D	9.8		10	0.385		0.393
E	5.8		6.2	0.228		0.244
e		1.27			0.050	
e3		8.89			0.350	
F	3.8		4.0	0.149		0.157
G	4.6		5.3	0.181		0.208
L	0.5		1.27	0.019		0.050
M			0.62			0.024
S	8° (max.)					



P013H

PLCC20 MECHANICAL DATA

DIM.	mm			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A	9.78		10.03	0.385		0.395
B	8.89		9.04	0.350		0.356
D	4.2		4.57	0.165		0.180
d1		2.54			0.100	
d2		0.56			0.022	
E	7.37		8.38	0.290		0.330
e		1.27			0.050	
e3		5.08			0.200	
F		0.38			0.015	
G			0.101			0.004
M		1.27			0.050	
M1		1.14			0.045	



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